BTS6303U



Wideband high linearity pre-driver amplifier 2.3 GHz - 4.2 GHz Rev. 5 — 18 October 2022

Product data sheet

General description

The BTS6303U is a wideband, high linearity, pre-driver amplifier for 5G massive MIMO infrastructure applications, with fast on-off switching to support TDD systems. The amplifier is designed to operate between 2.3 GHz and 4.2 GHz. It is housed in a 3 mm x 3 mm x 0.85 mm 16-terminal HVQFN package. The amplifier is ESD protected on all terminals.

Features and benefits 2

- High saturated output power P_{o(sat)} = 28 dBm, at 3.5 GHz
- High power gain G_p = 37 dB
- High linearity performance ACLR = -40 dBc
- Programmable bias current (via external resistor)
- · Fast switching to support TDD systems
- 5 V single supply, quiescent current 67 mA
- Small 16-terminal leadless package 3 mm x 3 mm x 0.85 mm
- · ESD protection on all terminals
- · Moisture sensitivity level 1

Applications

- · Wireless infrastructure 5G NR mMIMO
- · High linearity pre-driver
- · TDD systems



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4 Quick reference data

Table 1. Quick reference data

Unless otherwise specified, the following settings are used for measurements: f = 3.5 GHz; V_{CC} = 5 V; T_{amb} = 25 °C; input and output 50 Ω ; R_{SET} = 10 k Ω .

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|--------------------------------|---|-----|------|------|------|
| I _{CC} | supply current | ON state, P _o = 15 dBm | - | 94 | 116 | mA |
| | | ON state, quiescent | - | 67 | 87 | mA |
| | | OFF state | - | 1 | - | mA |
| G _p | power gain | ON state, f = 3.5 GHz | 35 | 37.9 | 41.2 | dB |
| | | OFF state | - | -50 | - | dB |
| P _{o(sat)} | saturated output power | f = 3.5 GHz | - | 28 | - | dBm |
| ACLR | adjacent channel leakage ratio | CP-OFDM with 100 MHz channel BW, QPSK modulation, and 60 kHz SCS, fully allocated, $P_{\rm o}$ = 15 dBm | - | -40 | - | dBc |

5 Ordering information

Table 2. Ordering information

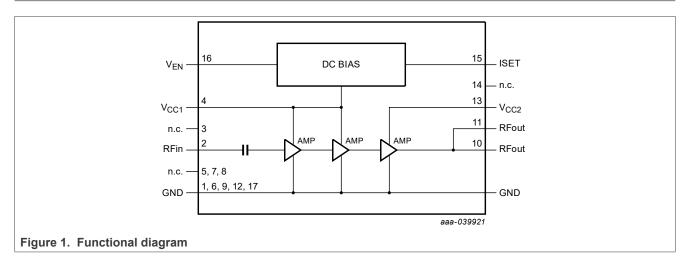
| Type number Orderable part | | Package | ackage | | | |
|----------------------------|-----------|---------|--|----------|--|--|
| | number | Name | Description | Version | | |
| BTS6303U | BTS6303UJ | HVQFN16 | 3 mm x 3 mm x 0.85 mm, 16 terminals no leads | SOT758-1 | | |

6 Marking

Table 3. Marking

| Type number | Marking code |
|-------------|--------------|
| BTS6303U | 33U |

7 Functional diagram



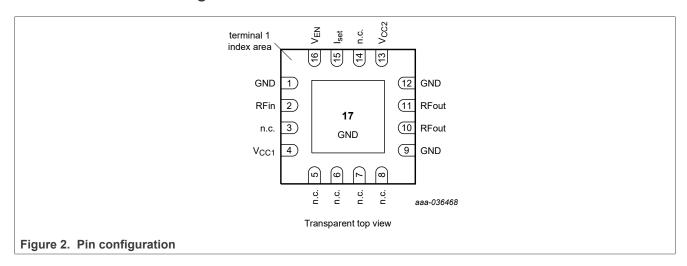
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8 Pinning information

8.1 Pinning



8.2 Pin description

Table 4. Pin description

| Pin | Symbol | Description |
|-------------------|------------------|--|
| 1, 9, 12 and 17 | GND | PCB ground |
| 2 | RFin | RF input |
| 3 | n.c. | PCB ground, or connect to RFin |
| 5, 6, 7, 8 and 14 | n.c. [1] | PCB ground |
| 10 and 11 | RFout | RF output; connect both to the same track |
| 4 | V _{CC1} | supply voltage |
| 13 | V _{CC2} | supply voltage |
| 15 | I _{set} | current set; connect to external resistor |
| 16 | V _{EN} | voltage enable; LOW = OFF state; HIGH = ON state |

^[1] n.c. means that pin is not connected inside package, and may be left floating in application

9 Functional description

Table 5. Shutdown control

| V _{EN} | voltage applied at pin V _{EN} [1] | State | Condition |
|-----------------|--|-------|-----------------------------------|
| LOW | $0 < V (V_{en}) < V_{IL(max)}$ | OFF | bias active, amplifier not active |
| HIGH | $V_{IH(min)} < V(V_{en}) < V_{I(max)}$ | ON | bias active, amplifier active |

^[1] V_{EN} can only be made HIGH, after supply voltage has been applied to pin V_{CC1}

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10 Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|----------------------|------------------------------------|--|------|--------|------|
| V _{CC} | supply voltage | | -0.3 | 6 | V |
| V _{EN} | enable voltage | | -0.3 | 4 | V |
| V _{I(set)} | current set voltage | | -0.3 | 4 | V |
| P _{i(RF)CW} | continuous waveform RF input power | ON state, OFF state | - | 10 | dBm |
| T _{stg} | storage temperature | | -50 | 150 | °C |
| Tj | junction temperature | | - | 175 | °C |
| MTTF | mean time to failure | at T _J = 165 °C | - | 1.6E6 | h |
| V _{ESD} | electrostatic discharge voltage | Human Body Model (HBM) According to ANSI/ESDA/JEDEC standard JS-001 | - | +/-2 | kV |
| | | Charged Device Model (CDM); According to ANSI/ESDA/JEDEC standard JS-002 | - | +/-500 | V |

11 Recommended operating conditions

Table 7. Recommended operating conditions

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|---------------------|--------------------------|------------|-----|------|-----|------|------|
| V _{CC} | supply voltage | | [1] | 4.75 | 5 | 5.25 | V |
| V _{IL} | LOW-level input voltage | | | 0 | - | 0.6 | V |
| V _{IH} | HIGH-level input voltage | | | 1.2 | - | 3.6 | V |
| V _{I(max)} | maximum input voltage | | | - | - | 3.6 | V |
| Z ₀ | characteristic impedance | | | - | 50 | - | Ω |
| T _{case} | case temperature | | | -40 | - | 115 | °C |

^[1] V_{CC} must be applied to pin V_{CC1} before, or at the same time as applying V_{CC} to pin V_{CC2}

12 Thermal characteristics

Table 8. Thermal characteristics

| Symbol | Parameter | Conditions | Тур | Unit |
|-------------------------|-------------------------------------|------------|-----|------|
| $R_{\text{th(j-case)}}$ | junction to case thermal resistance | [1] [2] | 50 | K/W |

^[1] Case is ground solder pad.

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^[2] Thermal resistance determined with device mounted, and device bottom case kept at constant temperature.

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13 Characteristics

Table 9. Characteristics

Unless otherwise specified, the following settings are used for measurements: f = 3.5 GHz; $V_{CC} = 5$ V; $T_{amb} = 25$ °C; input and output 50 Ω ; R_{SET} = 10 k Ω ; unless otherwise specified.

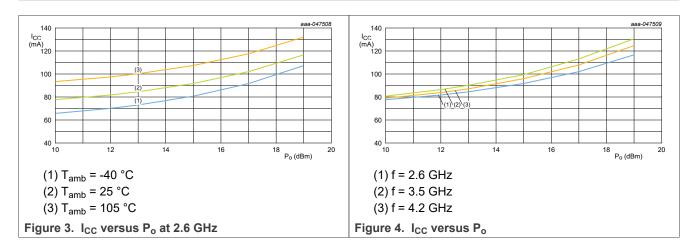
| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|----------------------|------------------------------------|--|-----|------|------|------|------|
| I _{CC} | supply current | ON state, P _o = 15 dBm | | - | 94 | 116 | mA |
| | | ON state, quiescent | | - | 67 | 87 | mA |
| | | OFF state | | - | 1.1 | - | mA |
| G _p | power gain | ON state | | | | | ' |
| | | f = 2.6 GHz | | 34.3 | 36.3 | 39 | dB |
| | | f = 3.5 GHz | | 35 | 37.9 | 41.2 | dB |
| | | f = 4.2 GHz | | 32.2 | 34.6 | 39 | dB |
| | | OFF state | | - | -50 | - | dB |
| G _{flat} | gain flatness | f = 2.3 GHz to 2.7 GHz | | - | 0.9 | - | dB |
| | | f = 3.3 GHz to 3.8 GHz | | - | 0.9 | - | dB |
| | | f = 3.8 GHz to 4.2 GHz | | - | 1.6 | - | dB |
| t _{d(grp)} | group delay time | f = 2.3 GHz to 2.7 GHz | | - | 0.3 | - | ns |
| | | f = 3.3 GHz to 3.8 GHz | | - | 0.3 | - | ns |
| | | f = 3.8 GHz to 4.2 GHz | | - | 0.3 | - | ns |
| P _{o(sat)} | saturated output power | f = 2.6 GHz | [1] | - | 27.5 | - | dBm |
| | | f = 3.5 GHz | [1] | - | 28 | - | dB |
| | | f = 4.2 GHz | [1] | - | 26.9 | - | dB |
| P _{L(1dB)} | output power at1 dB | f = 2.6 GHz | | - | 27.2 | - | dBm |
| | gain compression | f = 3.5 GHz | | - | 27.6 | - | dBm |
| | | f = 4.2 GHz | | - | 26.4 | - | dBm |
| IP3 _o | output third-order intercept point | 2-tone; tone spacing = 100 MHz; P _o = 15 dBm | | - | 29.2 | - | dBm |
| RLi | input return loss | | | - | 11.4 | - | dB |
| RLo | output return loss | | | - | 10 | - | dB |
| ISL _r | reverse isolation | | | - | 49 | - | dB |
| NF | noise figure | | [2] | - | 3.4 | - | dB |
| t _{s(pon)} | power-on settling time | V _{EN} from LOW to HIGH to output power reaching 90 % of final power | | - | 0.12 | - | μs |
| t _{s(poff)} | power-off settling time | V _{EN} from HIGH to LOW to output power reaching 10 % below initial power | | - | 0.06 | - | μs |
| K | Rollett stability factor | 1 MHz to 5 GHz | | 1 | - | - | |
| ACLR | adjacent channel leakage ratio | CP-OFDM with 100 MHz channel BW, QPSK modulation, and 60 kHz SCS, fully allocated, P _o = 15 dBm | | - | -40 | - | dBc |

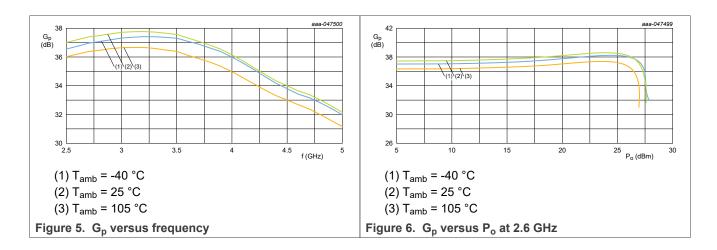
Connector and Printed-Circuit Board (PCB) losses have been de-embedded, 3 dB gain compression Connector and Printed-Circuit Board (PCB) losses have been de-embedded

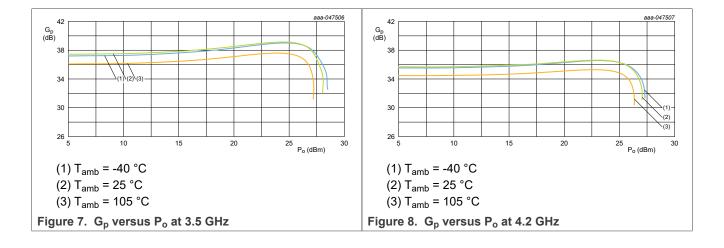
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14 Graphs



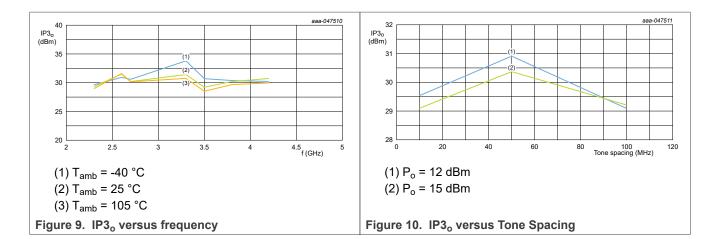


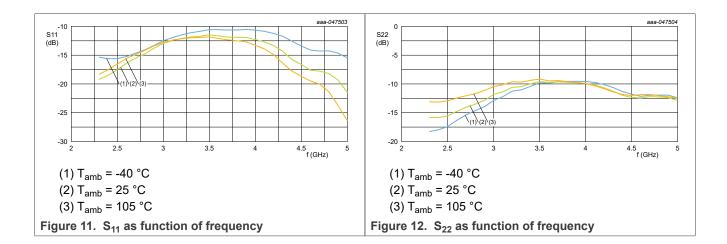


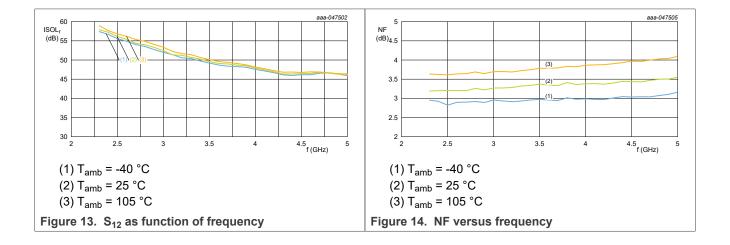
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15 Application information

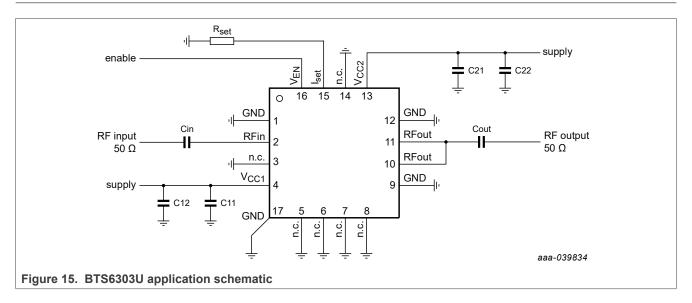


Table 10. List of components See <u>Figure 15</u> for schematics.

| Component | Description | Value | Remarks |
|------------------|-------------|--------|---|
| C _{in} | capacitor | 3.3 pF | for DC blocking / matching |
| C _{out} | capacitor | 18 pF | for DC blocking |
| C11, and C21 | capacitor | 10 nF | must be close (< 10 mm) to the IC |
| C12, and C22 [1] | capacitor | 1 μF | must be close (< 10 mm) to the IC |
| RSET | resistor | 10 ΚΩ | if lower resistor value is applied, a stability check is required |

[1] Optional

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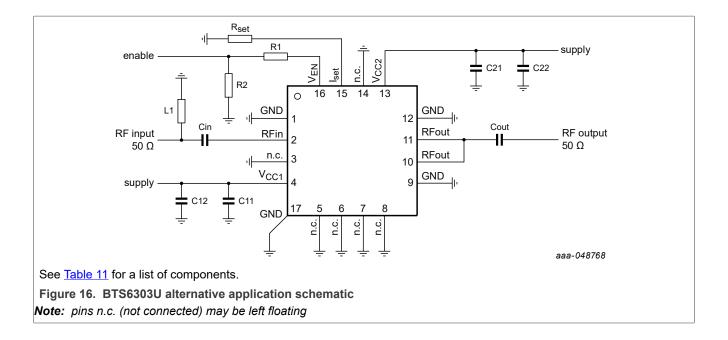


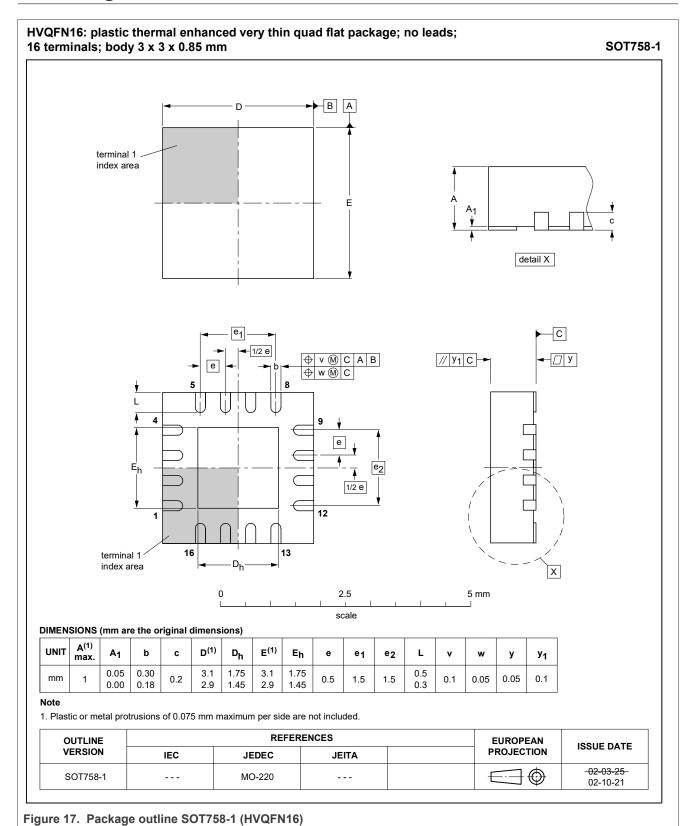
Table 11. List of components See <u>Figure 16</u> for schematics.

| Component | Description | Value | Remarks |
|------------------|-------------|--------|---|
| L1 | inductor | 3.3 nH | for optional matching / filtering |
| C _{in} | capacitor | 3.3 pF | for DC blocking / matching |
| C _{out} | capacitor | 18 pF | for DC blocking |
| C11, and C21 | capacitor | 10 nF | must be close (< 10 mm) to the IC |
| C12, and C22 [1] | capacitor | 1 μF | must be close (< 10 mm) to the IC |
| RSET | resistor | 10 ΚΩ | if lower resistor value is applied, a stability check is required |
| R1 | resistor | 5 ΚΩ | for EN pin protection |
| R2 | resistor | 100 ΚΩ | optional for EN pin protection |

[1] Optional

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16 Package outline

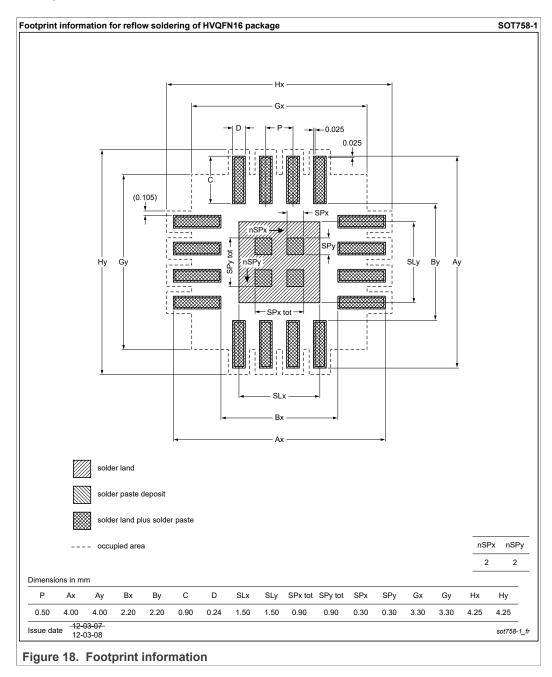


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16.1 Footprint and solder information



17 Handling information

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

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18 Abbreviations

Table 12. Abbreviations

| Acronym | Description |
|---------|--|
| 5G NR | 5 th generation new radio |
| ACLR | adjacent channel leakage ratio |
| CP-OFDM | cyclic prefix orthogonal frequency division multiplexing |
| ESD | electrostatic discharge |
| mMIMO | massive multiple-input multiple-output |
| PA | power amplifier |
| RF | radio frequency |
| TDD | time-division duplexing |

19 Revision history

Table 13. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes | |
|----------------|---|------------------------|---------------|----------------|--|
| BTS6303U V.5 | 20221018 | Product data sheet | - | BTS6303U V.4.1 | |
| modification | added graphs changed status to Product data sheet changed security status to public (no security status on the pdf) added MTTF to the Limiting values updated values for power gain added alternative application information | | | | |
| BTS6303U V.4.1 | 20220411 | Preliminary data sheet | - | BTS6303U V.4 | |
| modification | Corrected the revision number on the first page. The number was not in line with the revision history | | | | |
| BTS6303U V.4 | 20220411 | Preliminary data sheet | - | BTS6303U V.3 | |
| modification | changed values on several parameters | | | | |
| BTS6303U V.3 | 20211110 | Preliminary data sheet | - | BTS6303U V.2 | |
| modification | changed status to Preliminary data sheetchanged value on several parameters | | | | |
| BTS6303U V.2 | 20210326 | Objective data sheet | - | BTS6303U V.1.2 | |
| modification | changed Typical value on some characteristics changed ESD value on CDM from +/-1 KV to +/-500 V changed R_{SET} to 10 KΩ changed remarks on the capacitors in the List of components table changed condition on K factor in the Characteristics table | | | | |
| BTS6303U V.1.2 | 20201125 | Objective data sheet | - | BTS6303U V.1.1 | |
| modification | added official drawing of the Functional diagram | | | | |
| BTS6303U V.1.1 | 20201120 | Objective data sheet | - | BTS6303U V.1 | |
| | | | | | |

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Table 13. Revision history...continued

| Document ID | Release date | | Change notice | Supersedes |
|--------------|--|----------------------|---------------|------------|
| modification | changed values on some characteristics added condition 3.8 GHz to 4.2 GHz to G_{flat}, and t_{d(grp)} | | | |
| BTS6303U V.1 | 20201118 | Objective data sheet | - | - |

Wideband high linearity pre-driver amplifier 2.3 GHz - 4.2 GHz

20 Legal information

20.1 Data sheet status

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|-----------------------------------|-------------------------------|---|
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| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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